

Silicon NPN Triple Diffused

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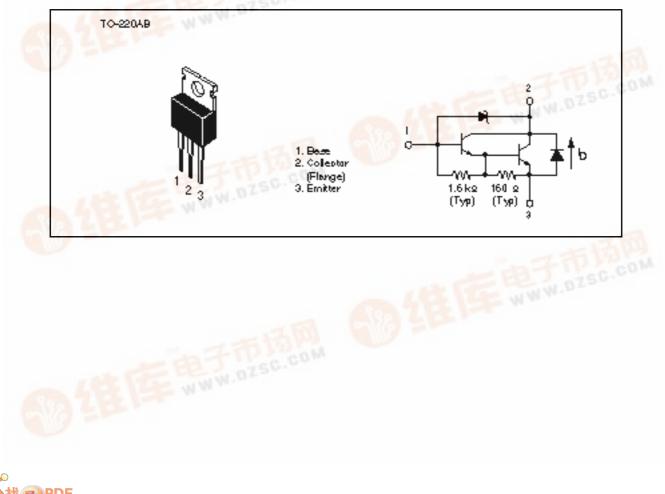
Application

WWW.DZSC High voltage switching, igniter

Feature

- Built-in High voltage zener diode (300 V)
- High Speed switching •

Outline





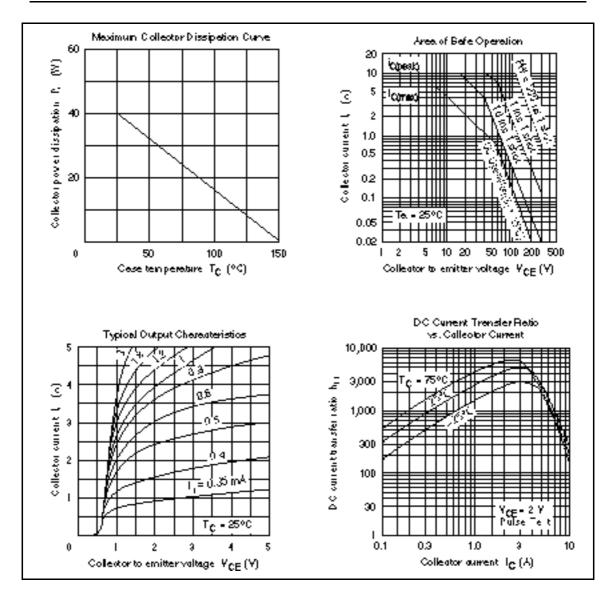
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

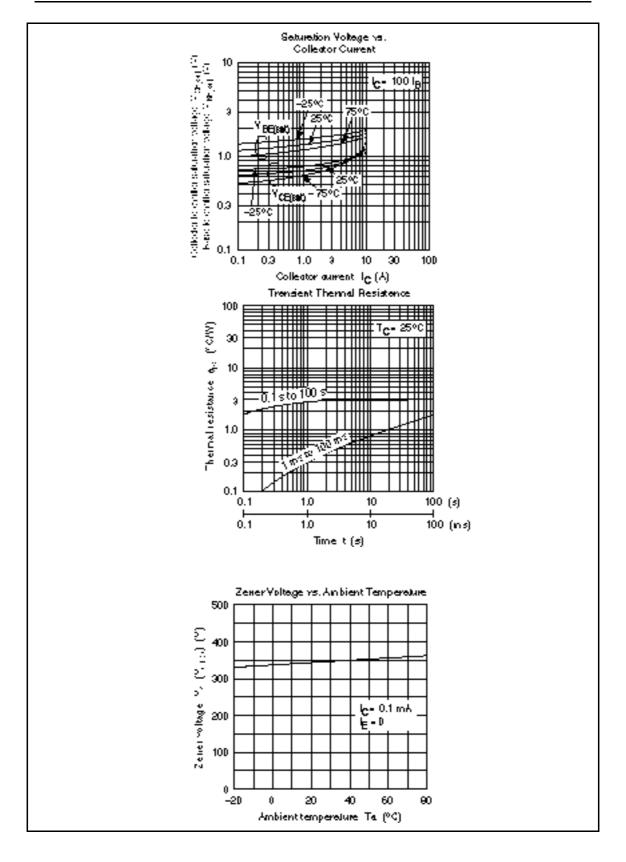
Item	Symbol	Rating	Unit V	
Collector to base voltage	V _{CBO}	300		
Collector to emitter voltage	V _{CEO}	300	V	
Emitter to base voltage	V _{EBO}	7	V A A A W	
Collector current	Ι _c	6		
Diode current	<mark>ا</mark> _ ^{*1}	6		
Collector peak current	I _{C(peak)}	10		
Collector power dissipation	P _c * ¹	40		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
Note: 1 Value at $T = 25^{\circ}C$				

Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(\text{BR})\text{CBO}}$	300	_	420	V	$I_{c} = 0.1 \text{ mA}, I_{E} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO}(\text{SUS})}$	300	_	_	V	$I_{c} = 3 \text{ A}, R_{BE} = , L = 10 \text{ mH}$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	7	_	_	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CEO}		_	100	μA	V_{ce} = 300 V, R_{be} =
DC current transfer ratio	h _{FE}	500	_	_		$V_{ce} = 2 V, I_c = 4 A$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.5	V	$I_{c} = 4 \text{ A}, I_{B} = 40 \text{ mA}$
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	_	_	2.0	V	$I_{\rm c} = 4$ A, $I_{\rm B} = 40$ mA
Emitter to collector diode forward voltage	V_{ECF}	—	—	3.5	V	I _F = 6 A
Turn on time	t _{on}	_	1.2	_	μs	$I_{c} = 4 \text{ A}, V_{cc} = 20 \text{ V}$
Storage time	t _{stg}	_	8.0		-	$I_{B1} = -I_{B2} = 40 \text{ mA}$
Fall time	t _f		8.0		_	





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